

Special Issue

Innovative Materials for Bioelectronics in Wearable and Implantable Applications

Message from the Guest Editors

The field of bioelectronics is undergoing transformation, showing great potential in wearable and implantable applications. Wearable electronics, such as smartwatches and electronic textiles. Implantable electronics, like pacemakers and neural stimulators. These applications rely on innovative materials that bridge the gap between biological systems and electronic devices. Flexible conductive materials like liquid metals and conductive polymers enhance signal transmission efficiency and sensing accuracy. Hydrogels, with tunable mechanical properties, can mimic the natural tissue environment, forming gentle interfaces with implantable devices. Energy conversion materials can harvest energy from biological motion and body heat, reducing reliance on external power sources. Stimulus-responsive materials can deliver electrical pulses through ultrasound, promoting nerve regeneration and tissue repair. This Special Issue emphasizes interdisciplinary research that bridges the fields of materials science, engineering, and biomedicine.

Guest Editors

Dr. Yang Zou

School of Medical Technology, Beijing Institute of Technology, Beijing 100081, China

Prof. Dr. Zhou Li

1. School of Biomedical Engineering, Tsinghua University, Beijing 100084, China

2. Tsinghua Changgung Hospital, School of Clinical Medicine, Tsinghua University, Beijing 100084, China

Deadline for manuscript submissions

31 December 2025



Micro

an Open Access Journal
by MDPI

Impact Factor 1.9
CiteScore 3.2



mdpi.com/si/224724

Micro
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
micro@mdpi.com

[mdpi.com/journal/
micro](https://mdpi.com/journal/micro)





Micro

an Open Access Journal
by MDPI

Impact Factor 1.9
CiteScore 3.2



[mdpi.com/journal/
micro](https://mdpi.com/journal/micro)



About the Journal

Message from the Editor-in-Chief

Editor-in-Chief

Prof. Dr. Zhou Li

1. School of Biomedical Engineering, Tsinghua University, Beijing
100084, China

2. Tsinghua Changgung Hospital, School of Clinical Medicine, Tsinghua
University, Beijing 100084, China

Author Benefits

Open Access:

free for readers, with article processing charges (APC) paid
by authors or their institutions.

High Visibility:

indexed within Scopus, ESCI (Web of Science) and other
databases.

Journal Rank:

CiteScore - Q2 (Engineering (miscellaneous))